



US00D830200S

(12) **United States Design Patent**  
**Kim et al.**

(10) **Patent No.:** **US D830,200 S**  
(45) **Date of Patent:** **\*\* Oct. 9, 2018**

(54) **HOUSING FOR PACKAGING SEMICONDUCTOR LIGHT EMITTING DEVICE**

(71) Applicant: **SEMICON LIGHT CO., LTD.**,  
Gyeonggi-do (KR)  
(72) Inventors: **Kyoung Min Kim**, Gyeonggi-do (KR);  
**Gye Oul Jeong**, Gyeonggi-do (KR)  
(73) Assignee: **SEMICON LIGHT CO., LTD.**,  
Gyeonggi-Do (KR)

(\*\*) Term: **15 Years**  
(21) Appl. No.: **29/582,157**  
(22) Filed: **Oct. 25, 2016**

(30) **Foreign Application Priority Data**

May 11, 2016 (KR) ..... 30-2016-0022110

(51) **LOC (11) Cl.** ..... **09-01**

(52) **U.S. Cl.**  
USPC ..... **D9/744; D26/138**

(58) **Field of Classification Search**  
USPC ..... D26/1, 24, 120, 138; D13/180; D9/737,  
D9/721, 748, 749, 756, 501, 414, 424,  
D9/434, 455-457, 759; D3/304, 295;  
D7/550.1, 553.1-553.8, 581, 586, 587;  
D24/227, 229, 230; 428/131; 229/120;  
220/4.21; 206/733, 528, 486, 485, 427,  
206/461, 828

CPC ..... H01J 5/48; H01J 5/50; H01J 19/54; A61B  
10/0096; A61B 50/20; A61B 50/30; A61C  
2202/00; A61J 1/16; A63B 57/203; B25H  
3/003; B44D 3/125; B65D 73/0092;  
B65D 81/025

See application file for complete search history.

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*Primary Examiner* — Cathron C Brooks

*Assistant Examiner* — W. A. Teddy Falloway

(74) *Attorney, Agent, or Firm* — Harness, Dickey &  
Pierce, P.L.C.

(57) **CLAIM**

The ornamental design for a housing for packaging semi-conductor light emitting device, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a housing for packaging semiconductor light emitting device, showing our new design;

FIG. 2 is a front view thereof;

FIG. 3 is a rear view thereof;

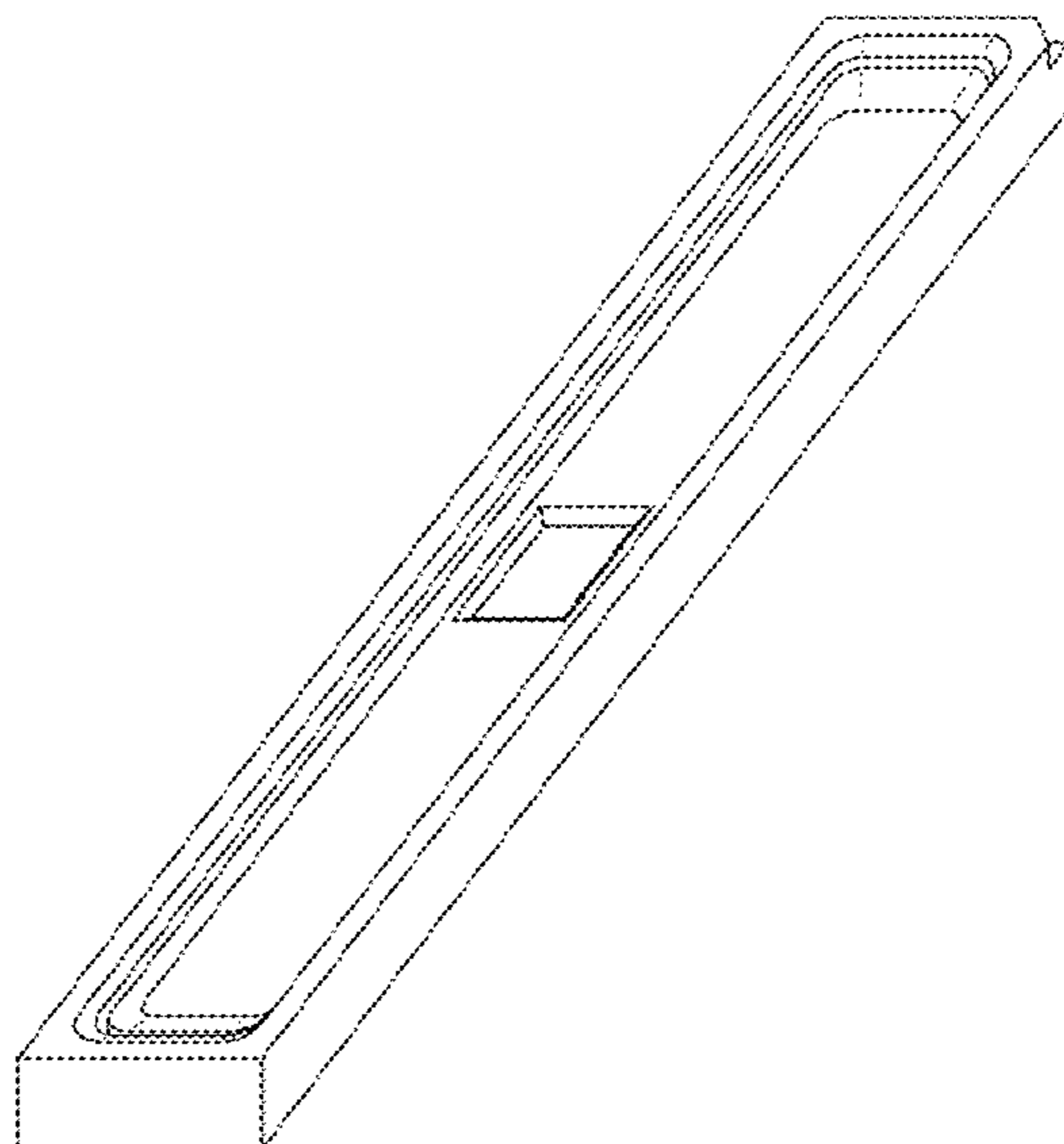
FIG. 4 is a left side view thereof;

FIG. 5 is a right side view thereof;

FIG. 6 is a top view thereof; and,

FIG. 7 is a bottom view thereof.

**1 Claim, 6 Drawing Sheets**



(56)

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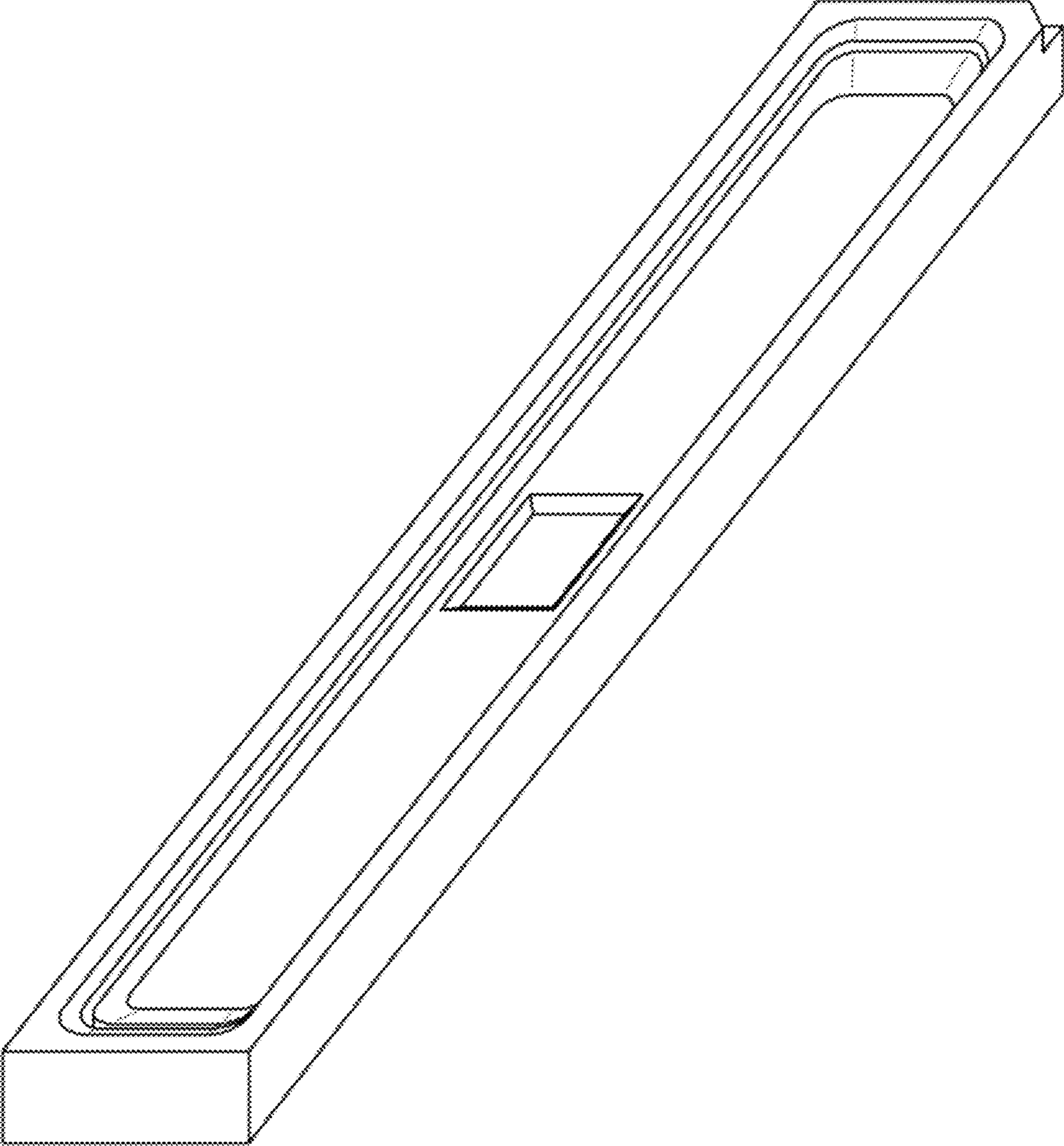
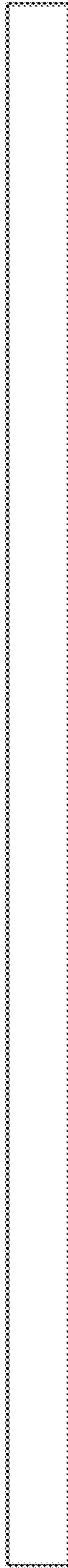


FIG. 1



FIG. 2



**FIG. 3**



**FIG. 4**



**FIG. 5**

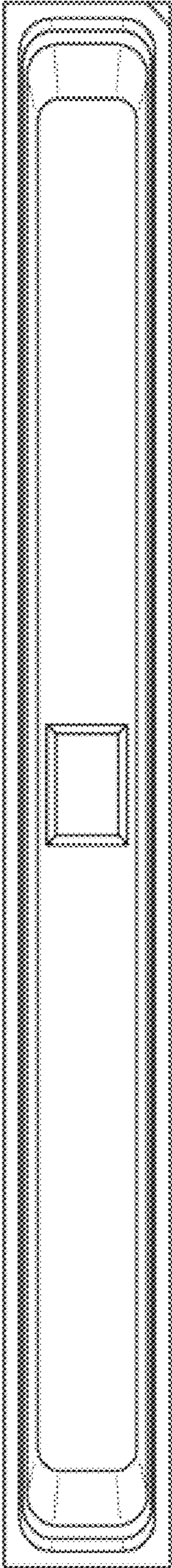


FIG. 6

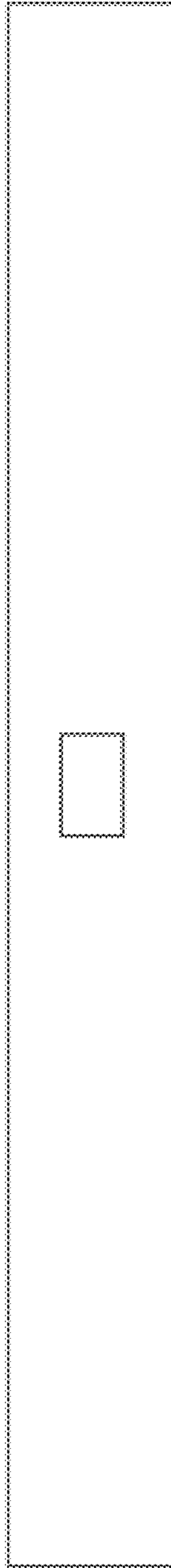


FIG. 7